

NOVARAY®

(0.80 mm) .0315" X (1.80 mm) .071"



EXTREME DENSITY & PERFORMANCE

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?NVAM

Insulator Material:

Black LCP
Contact Material: Copper Alloy Shield: Copper Alloy
Plating:
Au or Sn over
50 µ" (1.27 µm) Ni
Current Rating: Testing Now! RoHS Compliant:

Lead-Free Solderable:

Mates with:

PAM4

AGGREGATE DATA RATE (NRZ) 448 1344 1792 672 896 Gbps Gbps Gbps Gbps 1 Bank 2 Bank 2 Row 3 Row 4 Row 2 Row 3 Row 4 Row 8 Pairs 12 Pairs

STYLE

-DP

= 4 pairs per wafer

Two points of contact ensure a more reliable connection Minimal variance in data rate as stack height increases Up to 4.0 Tbps

PLATING

OPTION

-S

= 30 µ"

(0.76 µm)

Gold on

contact area

Matte Tin on

aggregate data rate (9 IEEE, 400 G channels) 16 Pairs 24 Pairs 32 Pairs

NO. OF

BANKS

= 1 Bank

-2

= 2 Banks

LEAD

02.0

(2 mm)

05.0

.0787"

= (5 mm)

NO. OF

ROWS

-02

= 2 Rows

-03

= 3 Rows

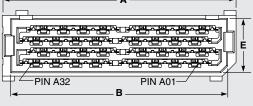


NVAM

WAILD IILIGITI			
NVAF	NVAM LEAD STYLE		
LEAD STYLE	-02.0	-05.0	
-05.0	(7.00) .276	(10.00) .394	
*Deceasing conditions will			

*Processing conditions will affect mated height.

= 4 Rows	.1969* Solder tall				
		NO. OF BANKS	Α	В	С
		-1	(21.75) .856	(18.65) .734	(19.45) .766
^	_1	-2	(37.75)	(34.65)	(35.45)



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H ↓		
	(1.32) (1.15) (0.80) .0315 (1.50)	1.32) 052 DIA
	NVAM-DP-04-2-05.0-X-X SHOWN	

NO. OF BANKS	Α	В	С
-1	(21.75)	(18.65)	(19.45)
	.856	.734	.766
-2	(37.75)	(34.65)	(35.45)
	1.486	1.364	1.396

.071

NO. OF ROWS	D	E	F
-02	(6.20)	(4.80)	(7.80)
	.244	.189	.307
-03	(8.00)	(6.60)	(9.60)
	.315	.260	.378
-04	(9.80)	(8.40)	(11.40)
	.386	.331	.449

DIA

SOLDER

TYPE

-2 Lead-Free

Solder

Charge

REEL

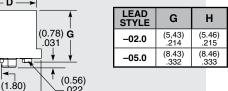
(Required callout)

-TR

= Tape & Reel

–FR = Full Reel Tape & Reel Packaging (Must order max. quantities per reel Contact Samtec

for parts per reel)



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Some sizes, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice